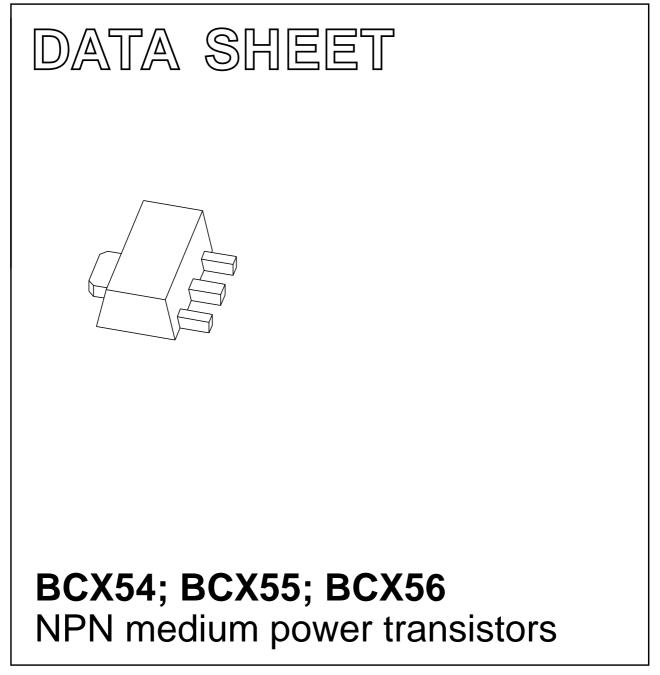
DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 1999 Apr 19 2001 Oct 10



FEATURES

- High current (max. 1 A)
- Low voltage (max. 80 V).

APPLICATIONS

• Driver stages of audio and video amplifiers.

DESCRIPTION

NPN medium power transistor in a SOT89 plastic package. PNP complements: BCX51, BCX52 and BCX53.

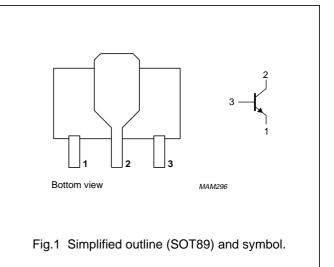
MARKING

TYPE NUMBER			MARKING CODE	
BCX54	BA	BCX55-16	BM	
BCX54-10	BC	BCX56	BH	
BCX54-16	BD	BCX56-10	BK	
BCX55	BE	BCX56-16	BL	
BCX55-10	BG			

BCX54; BCX55; BCX56

PINNING

PIN	DESCRIPTION	
1	emitter	
2	collector	
3	base	



BCX54; BCX55; BCX56

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter			
	BCX54		_	45	V
	BCX55		_	60	V
	BCX56		_	100	V
V _{CEO}	collector-emitter voltage	open base			
	BCX54		_	45	V
	BCX55		_	60	V
	BCX56		-	80	V
V _{EBO}	emitter-base voltage	open collector	-	5	V
I _C	collector current (DC)		-	1	A
I _{CM}	peak collector current		-	1.5	A
I _{BM}	peak base current		-	0.2	A
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	-	1.3	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Note

1. Device mounted on a printed-circuit board, single sided copper, tinplated, mounting pad for collector 6 cm². For other mounting conditions, see *"Thermal considerations for SOT89 in the General Part of associated Handbook"*.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	note 1	94	K/W
R _{th j-s}	thermal resistance from junction to soldering point		14	K/W

Note

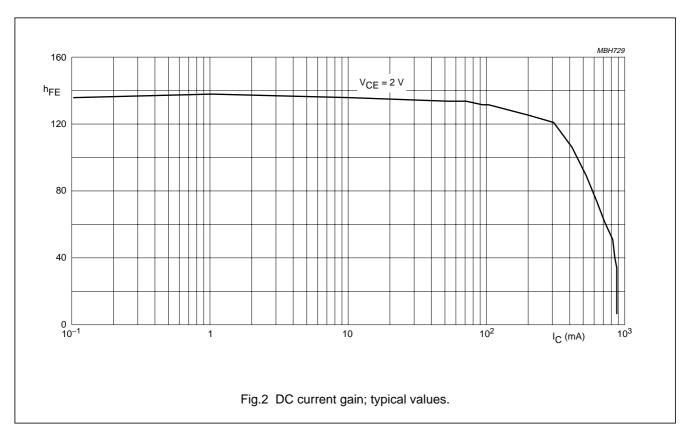
1. Device mounted on a printed-circuit board, single sided copper, tinplated, mounting pad for collector 6 cm². For other mounting conditions, see *"Thermal considerations for SOT89 in the General Part of associated Handbook"*.

BCX54; BCX55; BCX56

CHARACTERISTICS

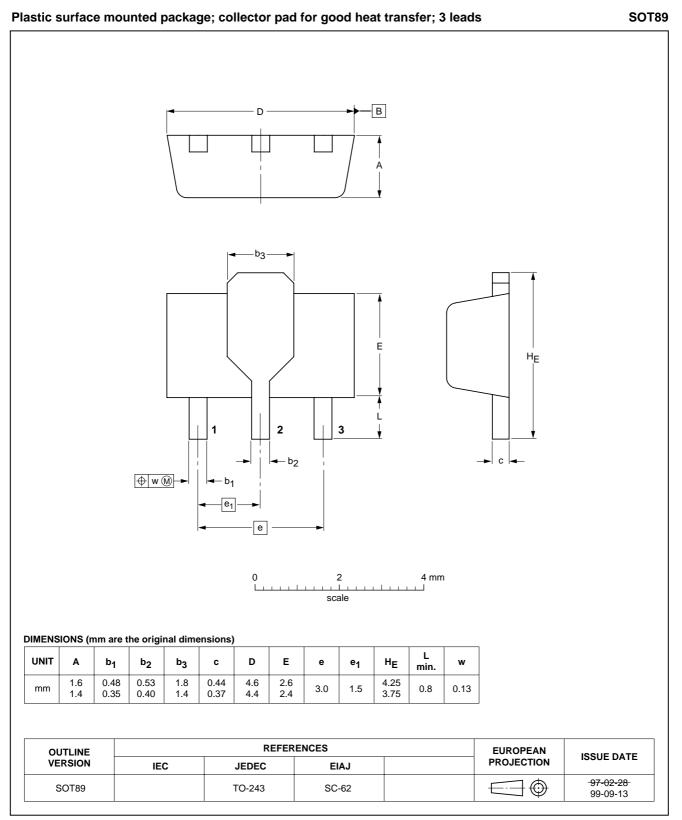
 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector cut-off current	I _E = 0; V _{CB} = 30 V	-	-	100	nA
		$I_E = 0; V_{CB} = 30 V; T_j = 125 °C$	-	-	10	μA
I _{EBO}	emitter cut-off current	I _C = 0; V _{EB} = 5 V	_	-	100	nA
h _{FE}	DC current gain	V _{CE} = 2 V; (see Fig.2)				
		$I_{\rm C} = 5 \rm{mA}$	63	-	-	
		I _C = 150 mA	63	-	250	
		I _C = 500 mA	40	-	_	
	DC current gain	$I_{C} = 150 \text{ mA}; V_{CE} = 2 \text{ V}; \text{ (see Fig.2)}$				
	BCX54-10; 55-10; 56-10		63	-	160	
	BCX54-16; 55-16; 56-16		100	-	250	
V _{CEsat}	collector-emitter saturation voltage	I _C = 500 mA; I _B = 50 mA	-	-	0.5	V
V _{BE}	base-emitter voltage	I _C = 500 mA; V _{CE} = 2 V	_	_	1	V
f _T	transition frequency	I _C = 10 mA; V _{CE} = 5 V; f = 100 MHz	_	130	_	MHz
$\frac{h_{FE1}}{h_{FE2}}$	DC current gain ratio of the complementary pairs	I _C = 150 mA; V _{CE} = 2 V	_	1.3	1.6	



BCX54; BCX55; BCX56

PACKAGE OUTLINE



BCX54; BCX55; BCX56

DATA SHEET STATUS

DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITIONS
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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Notes

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- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

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BCX54; BCX55; BCX56

NOTES

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